

6A Avg.

400 Volts

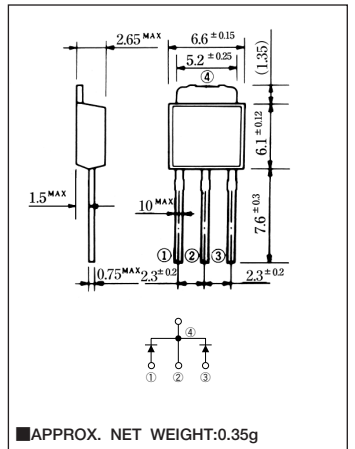
FRED

ECU06A40

■最大定格 Maximum Ratings

Item	Symbol	Conditions	Unit
くり返しピーク逆電圧 Repetitive Peak Reverse Voltage	$V_{RRM}$	400	V
平均整流電流 Average Rectified Forward Current	$I_O$	$T_c=103^{\circ}C$ Tc: Case Temperature	6.0
		$T_a=29^{\circ}C^*$	1.5
実効順電流 R.M.S. Forward Current	$I_F(RMS)$	6.66	A
サージ順電流 Surge Forward Current	$I_{FSM}$	45	A
動作接合温度範囲 Operating Junction Temperature Range	$T_{jw}$	50Hz正弦全波, 1サイクル, 非くり返し 50Hz Full Sine Wave, 1cycle, Non-repetitive	$-40 \sim +150$
保存温度範囲 Storage Temperature Range	$T_{stg}$		$-40 \sim +150$

■OUTLINE DRAWING(mm)



■電氣的・熱的特性 Electrical/Thermal Characteristics

Item	Symbol	Conditions	Min.	Typ.	Max.	Unit
ピーク逆電流 Peak Reverse Current	$I_{RM}$	$T_j=25^{\circ}C, V_{RM}=V_{RRM}$ , 一素子あたり Per Diode	—	—	20	$\mu A$
ピーク順電圧 Peak Forward Voltage	$V_{FM}$	$T_j=25^{\circ}C, I_{FM}=3A$ , 一素子あたり Per Diode	—	1.37	1.55	V
逆回復時間 Reverse Recovery Time	trr	$I_{FM}=3A, -di/dt=50 A/\mu s, T_j=25^{\circ}C$	—	18	30	ns
熱抵抗 Thermal Resistance	$R_{th(j-a)}$	接合部・周囲間 Junction to Ambient	—	—	80	$^{\circ}C/W$
	$R_{th(j-c)}$	接合部・ケース間 Junction to Case	—	—	5	$^{\circ}C/W$

\* Print Land =20×20 mm

■定格・特性曲線

FIG.1

順電圧特性  
FORWARD CURRENT VS. VOLTAGE

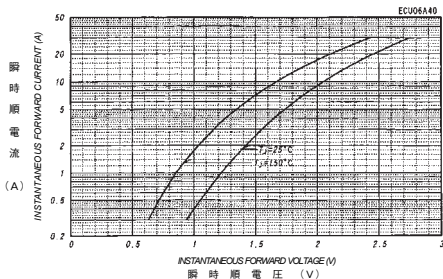


FIG.2

平均順電力損失特性  
AVERAGE FORWARD POWER DISSIPATION

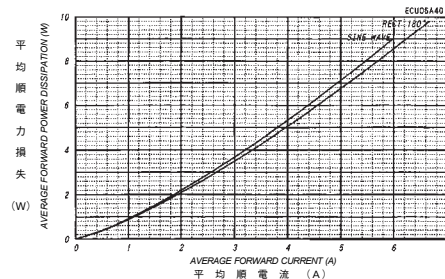


FIG.3

平均順電流－ケース温度定格  
AVERAGE FORWARD CURRENT VS. CASE TEMPERATURE

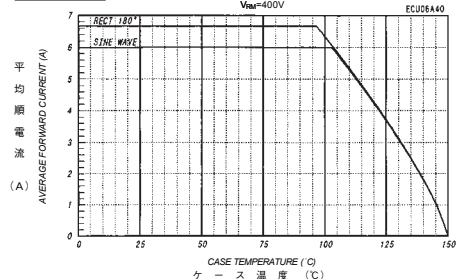


FIG.4

平均順電流－周囲温度定格  
AVERAGE FORWARD CURRENT VS. AMBIENT TEMPERATURE  
P.C. Board mounted (Print land=20×20mm)

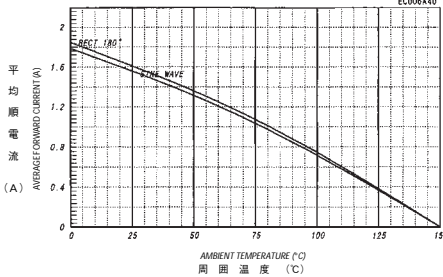


FIG.5

サージ順電流定格  
SURGE CURRENT RATINGS  
f=50Hz, Sine Wave, Non-Repetitive, No Load

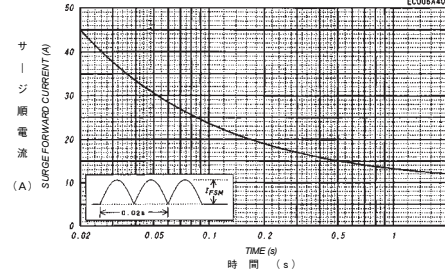


FIG.6

サージ実効順電流定格  
RMS SURGE CURRENT RATINGS  
T=40°C, Non-Repetitive, No Load

